



PRODUCT SUMMARY

The HL7062 is a surface mountable (SMD) pick-off tee that provides flat frequency response on both the thru and pick-off lines from DC to over 30 GHz.

They are suitable for use in 100 Gbps Ethernet, 100 Gbps Long Haul, and 40 Gbps (D)QPSK communications systems, high-speed analog-to-digital conversion, frequency response testing for differential devices, and many other applications.

DEPLOYMENT NOTES

The HL7062 is packaged in a leadless 4 x 4 mm surface mount package.

MODELS & OPTIONS

The following models are available:

HL7062, SMD package *HL7062-EVAL*, mounted on evaluation board.

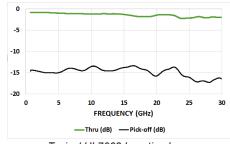
HL7062 Surface Mount Pick-off Tee (DC to 30 GHz)

Features and Technical Specifications

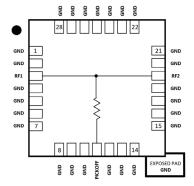
Bandwidth	DC to 30 GHz
Insertion Loss	1 \pm 1 dB, thru line 15 \pm 2 dB, pick-off line See <i>Fig.</i> 1
Return Loss	> 15 dB, f < 20 GHz, thru line > 5 dB, pick-off line See Fig. 2
Group Delay	40 ps See Fig. 3
Rise Time (10-90%)	12 ps
Impedance	50 Ω
Interface	Solderable pads, Gold ENIG
Reflow Profile	Solderable pads, Gold ENIG Designed to be compatible with a SAC305 thermal reflow profile: - max reflow time above 217 C is 90 seconds - peak reflow temperature is 245 C, not to be exceeded
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Reflow Profile	Designed to be compatible with a SAC305 thermal reflow profile: - max reflow time above 217 C is 90 seconds - peak reflow temperature is 245 C, not to be exceeded 28 lead 4 x 4 mm SMT package; 16 mm²
Reflow Profile Dimensions	Designed to be compatible with a SAC305 thermal reflow profile: - max reflow time above 217 C is 90 seconds - peak reflow temperature is 245 C, not to be exceeded 28 lead 4 x 4 mm SMT package; 16 mm² See Fig. 4



HL7062, 4 x 4 mm QFN Package, 28 pin



Typical HL7062 Insertion Loss



HL7062 Schematic and Port Assignments

HL7061 Insertion Loss and Return Loss

Figure 1 shows the insertion loss of the thru and pick-off lines of the HL7062 from DC to 30GHz. Figure 2 shows the return loss of the HL7062 over the same bandwidth.

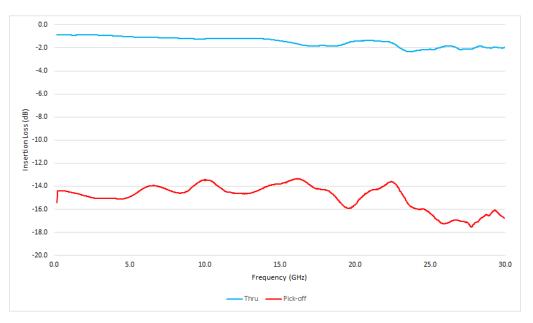


Figure 1: Typical HL7062 Insertion Loss

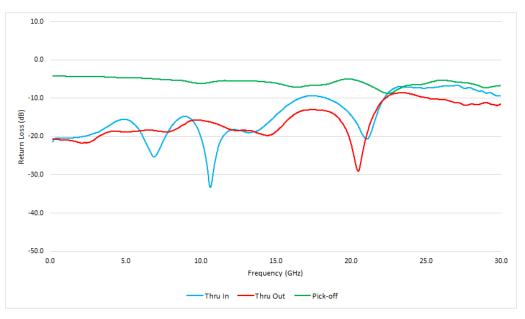


Figure 2: Typical HL7062 Return Loss

HL7062 Group Delay

Figure 3 shows the Group Delay on a typical HL7062 from DC to 30GHz.

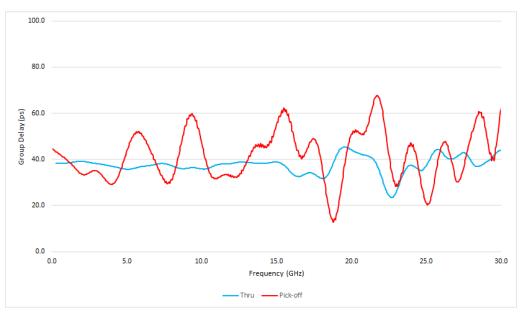


Figure 3: Typical HL7062 Group Delay

HL7062 Dimensional Drawing

Figure 4 shows a mechanical drawing of an HL7062. *Figure 5* shows an HL7062 mounted to the evaluation board. Unless otherwise noted, all units are shown in mm.

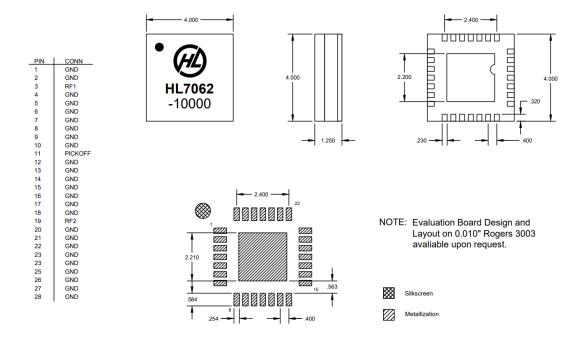


Figure 4: HL7062 Mechanical Drawing

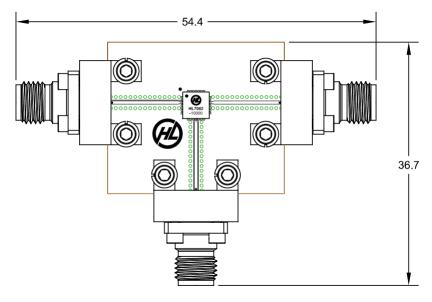


Figure 5: HL7062 Evaluation Board Dimensions